	520 524		
182	(thin ad) film) and affinity and substrate and (organic ad) semiconductor) and (ito or glass) and inorganic	EPO: JPO: DERNENT: 14:05	2005/04/26
	(thin ed) film) and substrate and (affinity same (organic ad) semiconductor)) and (ito or glass) and inorganic and polyimide and cransistor	US-PGPUB; USPAT; EPO; JPO; DERWENT;	2005/04/26
	517 and 518	US-PGPUB; USPAI; EPO; JPO; DERNENI;	2005/04/26
	(thin adj film) and affinity and substrate and (organic adj semiconductor) and (ito or glass) and inorganic and polyimide and @pd>~20050111"	US-PGPUB; USFAT; 2005/0 EFO; JPO; DERMENT; 13:59	2005/04/26
	(thin ad) film) and substrate and (affinity same (organic ad) semiconductor)) and (ito or glass) and inorganic and polyimide and translator and (\$poly.2001); (\$poly.2001); (\$poly.2001); (\$poly.2001);	US-PGPUB; USPAT; EPO; JPO; DERWENT;	2005/04/26
6011	<u> </u>	US-PGPUB; USPAT; EPO; JPO; DERWENT;	2005/04/26
		US-PGPUB; USPAI; EPO; JPO; DERNENI;	2005/04/26
65	(thin adj film) and affinity and substrate and (organic adj semiconductor) and (ito or glass) and inorganic and polyimide	US-PGPUB: USPAT: 2005/(EPO: JPO: DERNENT: 13:58	2005/04/26 13:58
374	(thin ad) film) and affinity and substrate and (organic ad) semiconductor) and (ito or glass) and inorganic	US-PGPUB: USPAT: EPO: JPO: DERNENT;	2005/02/01
174	(thin ed) film) and affinity and substrate and (organic ad) semiconductor) and (ito or glass) and inorganic	US-PGPUB; USPAT; EPO; JPO; DERNENT;	2005/02/01
5703	257/40,59,88,89.ccls. 438/29,30,70,99.ccls.	US-PGPUB; USPAT; Z005/1 EPO; JPO; DERWENT; 16:01	2005/02/01
44	(thin ed) film) and affinity and substrate and (organic ad) semiconductor) and (ito or glass) and inorganic and polyimide and transistor	US-FGPUB; USPAT; 2005/(EPO; JPO; DERWENT; 16:35	2005/01/28
4541	(thin adj film) and affinity and substrate and organic and (ito or glass)	US-FGFUB; USPAI; EPO; JPO; DERWENI;	2005/01/29
211	(thin adj film) and affinity and substrate and (organic adj semiconductor) and (ito or glass)	US-PGPUB; USPAI; EPO; JPO; DERWENI;	2005/01/28
	("5948577" "5691011").pn.	US-PGPUB; USPAI; EPO; JPO; DERMENI;	2005/01/28
	"09/423969".pn.	US-FGFUB; USPAT; EPO; JPO; DERNENT;	2005/01/11
	-09/423969"	US-FGFUS; USPAI; EPO; JPO; DERWENI;	2005/01/11
	"UP 11040354 A"	JPO	2005/01/11
	#UP 07234314 A."	JPO	2005/01/11 13:39
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		JPO	2005/01/11 13:38
		JPO	2005/01/11
	"JP 63305920 A"	JPO	2005/01/11 13:36
	("6373197").pn.	US-PGPUB: USPAT:	11/10/2002

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